

RF MOSFET Power Transistor, 30W, 12V

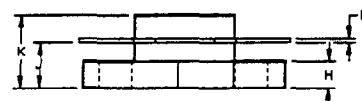
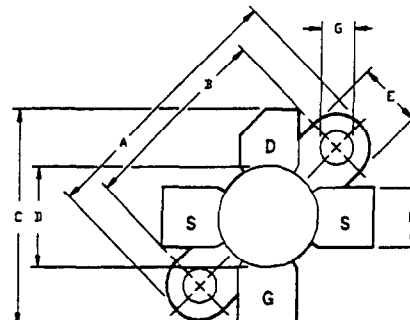
2 - 175 MHz

DU1230S

V2.00

Features

- N-Channel Enhancement Mode Device
- DMOS Structure
- Lower Capacitances for Broadband Operation
- High Saturated Output Power
- Lower Noise Figure Than Bipolar Devices
- Specifically Designed for 12 Volt Applications



Absolute Maximum Ratings at 25°C

Parameter	Symbol	Rating	Units
Drain-Source Voltage	V_{DS}	40	V
Gate-Source Voltage	V_{GS}	20	V
Drain-Source Current	I_{DS}	8	A
Power Dissipation	P_D	175	W
Junction Temperature	T_J	200	°C
Storage Temperature	T_{STG}	-55 to +150	°C
Thermal Resistance	θ_{JC}	1	°C/W

LETTER DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	24.64	24.89	.970	.980
B	18.29	18.54	.720	.730
C	20.07	20.83	.790	.820
D	9.47	9.73	.373	.383
E	6.22	6.48	.245	.255
F	5.64	5.79	.222	.228
G	2.92	3.30	.115	.130
H	2.29	2.67	.090	.105
J	4.04	4.55	.159	.179
K	6.58	7.39	.259	.291
L	.10	.15	.004	.006

Electrical Characteristics at 25°C

Parameter	Symbol	Min	Max	Units	Test Conditions
Drain-Source Breakdown Voltage	BV_{DSS}	40	-	V	$V_{GS}=0.0\text{ V}$, $I_{DS}=10.0\text{ mA}$
Drain-Source Leakage Current	I_{DSS}	-	2.0	mA	$V_{DS}=15.0\text{ V}$, $V_{GS}=0.0\text{ V}$
Gate-Source Leakage Current	I_{GSS}	-	2.0	μA	$V_{GS}=20.0\text{ V}$, $V_{DS}=0.0\text{ V}$
Gate Threshold Voltage	$V_{GS(TH)}$	2.0	6.0	V	$V_{DS}=10.0\text{ V}$, $I_{DS}=200\text{ mA}$
Forward Transconductance	G_M	1.0	-	S	$V_{DS}=10.0\text{ V}$, $I_{DS}=2000\text{ mA}$, $\Delta V_{GS}=1.0\text{ V}$
Input Capacitance	C_{ISS}	-	100	pF	$V_{DS}=12.0\text{ V}$, $F=1.0\text{ MHz}$
Output Capacitance	C_{OSS}	-	120	pF	$V_{DS}=12.0\text{ V}$, $F=1.0\text{ MHz}$
Reverse Capacitance	C_{RSS}	-	24	pF	$V_{DS}=12.0\text{ V}$, $F=1.0\text{ MHz}$
Power Gain	G_P	9.0	-	dB	$V_{DD}=12.0\text{ V}$, $I_{DQ}=200\text{ mA}$, $P_{OUT}=30\text{ W}$, $F=175\text{ MHz}$
Drain Efficiency	η_D	60	-	%	$V_{DD}=12.0\text{ V}$, $I_{DQ}=200\text{ mA}$, $P_{OUT}=30\text{ W}$, $F=175\text{ MHz}$
Load Mismatch Tolerance	VSWR-T	-	30:1	-	$V_{DD}=12.0\text{ V}$, $I_{DQ}=200\text{ mA}$, $P_{OUT}=30\text{ W}$, $F=175\text{ MHz}$

Specifications Subject to Change Without Notice.

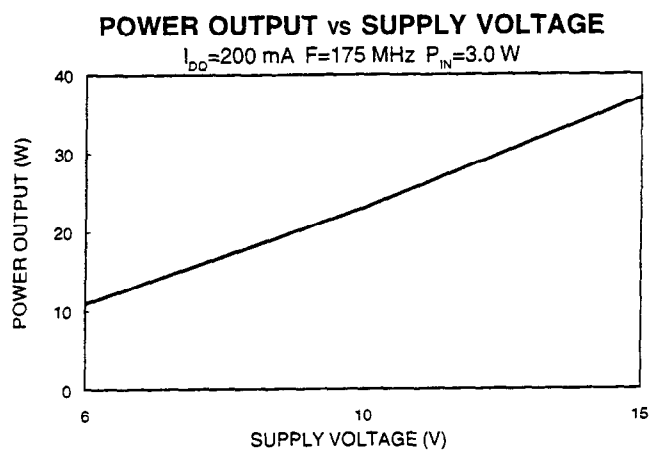
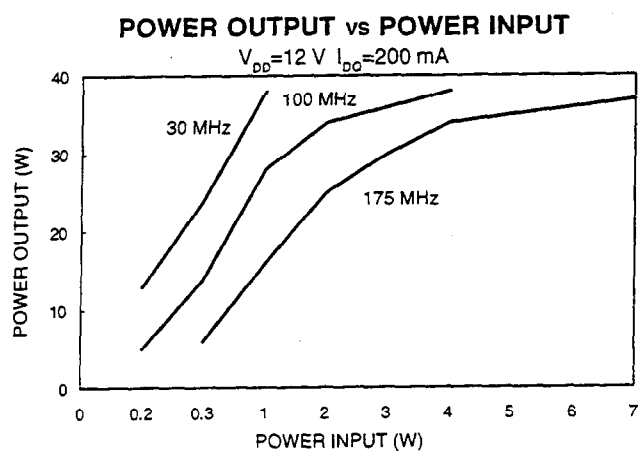
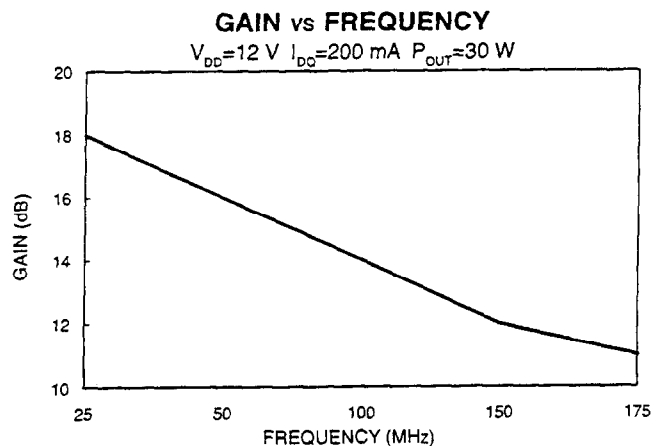
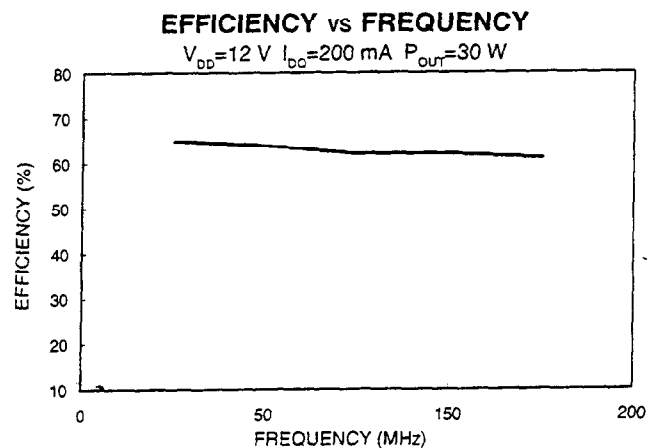
M/A-COM, Inc.

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Typical Broadband Performance Curves



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Typical Device Impedance

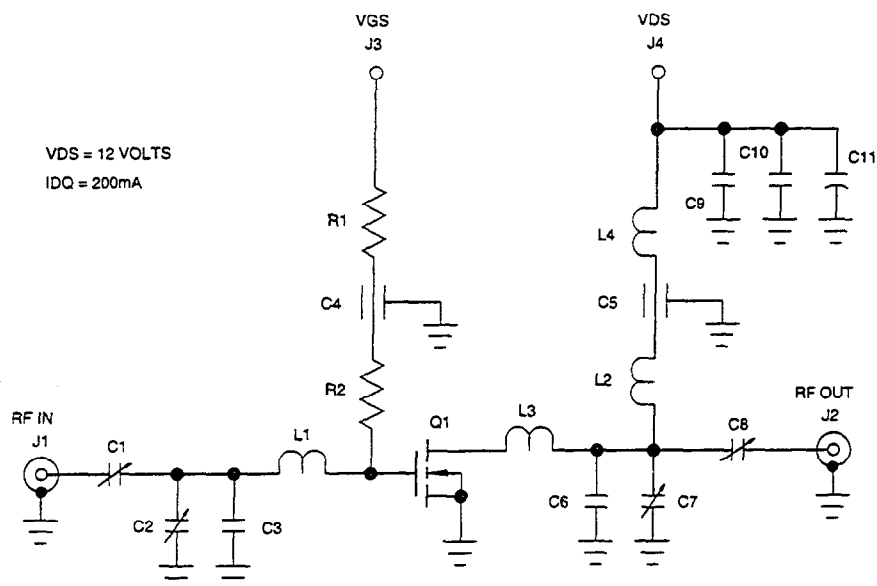
Frequency (MHz)	Z_{IN} (OHMS)	Z_{LOAD} (OHMS)
30	12.0 - j 14.0	2.5 + j 3.0
100	4.0 - j 8.0	2.5 - j 1.0
175	2.0 - j 2.5	2.5 - j 0.5

$$V_{DD}=12\text{ V}, I_{DQ}=200\text{ mA}, P_{OUT}=30\text{ Watts}$$

Z_{IN} is the series equivalent input impedance of the device from gate to source.

Z_{LOAD} is the optimum series equivalent load impedance as measured from drain to ground.

RF Test Fixture



PARTS LIST

C1,C8	ARCO NO. 462 TRIMMER CAPACITOR 5-80pF
C2,C7	ARCO NO. 422 TRIMMER CAPACITOR 4-40pF
C3	SEMCO CAPACITOR 50pF
C4,C5	FEEDTHROUGH CAPACITOR 0.001uF
C6	SEMCO CAPACITOR 30pF
C9	SEMCO CAPACITOR 1000pF
C10	MONOLITHIC CERAMIC CAPACITOR 0.01uF
C11	ELECTROLYTIC CAPACITOR 50uF 50 V.
L1,L3	NO. 12 AWG COPPER WIRE X 1"
L2	8 TURNS OF NO. 20 AWG ENAMEL WIRE ON '0.25", CLOSE WOUND
L4	12 TURNS OF NO. 20 AWG ON '0.25", CLOSE WOUND
R1,R2	RESISTOR 100K OHMS
Q1	DU1230S
BOARD	FR4 0.062"

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